

Wide Frequency range Timing-Safe™ Peak EMI reduction IC

General Features

- 1x, LVCMOS Timing-Safe™ Peak EMI Reduction
- Input frequency:

2MHz - 16MHz @ 2.5V

2MHz - 20MHz @ 3.3V

Output frequency (Timing-Safe™):

2MHz - 16MHz @ 2.5V

2MHz - 20MHz @ 3.3V

- Analog Spread Selection up to ±1.5%
- External Input-Output Delay Control option
- Power Down option for Power Save mode
- Supply Voltage: 2.5V±0.2V

 $3.3V \pm 0.3V$

- Commercial temperature range
- 8 pin, TSSOP, and TDFN(2X2) COL packages
- The First True Drop-in Solution

Functional Description

PCS3P73Z01AW is a 2.5V/3.3V versatile EMI reduction IC based on PulseCore Semiconductor's patent pending Timing-Safe™ technology. PCS3P73Z01AW accepts one

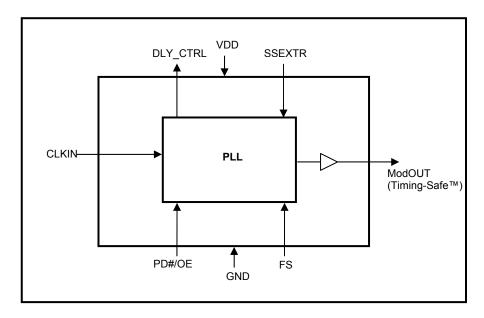
input from an external reference, and locks on to it delivering a 1x Timing-Safe™ clock. PCS3P73Z01AWI has IU.com a Frequency Selection (FS) control that facilitates selecting one of the two frequency ranges within the operating frequency range. Refer to the frequency Selection table for details. The device has an SSEXTR pin to select different deviation and associated Input-Output Skew (Tskew), depending upon the value of an external resistor connected between SSEXTR and GND. PCS3P73Z01AW has a DLY_CTRL for adjusting the Input-Output clock delay, depending upon the value of capacitor connected at this pin to GND. PD#/OE provides the Power Down option. Outputs will be tri-stated when power down is active.

PCS3P73Z01AW operates from a 2.5V/3.3V supply and is available in an 8 Pin TSSOP, and TDFN (2X2) COL Packages, over Commercial temperature range.

Application

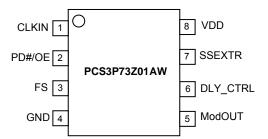
PCS3P73Z01AW is targeted for use in Displays, Camera modules and SDRAM memory interface systems.

Block Diagram





Pin Configuration



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Pin Description

Pin#	Туре	Pin Name	Description
1	1	CLKIN	External reference Clock input.
2	_	PD#/OE	Power Down. Pull LOW to enable Power Down. Outputs will be tri-stated when power down is enabled. Pull HIGH to disable power down and enable output.
3	Ι	FS	Frequency Select (see Frequency Selection table for details).
4	Р	GND	Ground
5	0	ModOUT	Buffered modulated Timing-Safe™ clock output
6	0	DLY_CTRL	External Input-Output Delay control
7	1	SSEXTR	Analog Spread Selection through external resistor to GND.
8	Р	VDD	2.5V / 3.3V supply Voltage

Frequency Selection Table

VDD	DD FS Frequency(MHz)	
0.5)/	0	2-6
2.5V	1	6-16
0.017	0	2-6
3.3V	1	6-20

Absolute Maximum Rating

Symbol	Parameter	Rating	Unit
V_{DD}	Voltage on any pin with respect to Ground	-0.5 to +4.6	V
T _{STG}	Storage temperature	-65 to +125	°C
Ts	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
T_DV	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV

Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.



Operating Conditions

Parameter	Description	Min	Max	Unit
$V_{DD(3.3V)}$	Supply Voltage	3.0	ww 3:6 Da	taS ly eet4
V _{DD(2.5V)}	Supply Voltage	2.3	2.7	V
T _A	Operating Temperature (Ambient Temperature)	0	+70	°C
C_L	Load Capacitance		10	pF
C _{IN}	Input Capacitance		7	pF

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Electrical Characteristics for 2.5V Supply

Parameter	Description	Test C	Test Conditions		Тур	Max	Unit
V_{DD}	Supply Voltage			2.3	2.5	2.7	V
V_{IL}	Input LOW Voltage					0.7	V
V _{IH}	Input HIGH Voltage			1.7			V
I _{IL}	Input LOW Current	$V_{IN} = 0V$				50	μA
I _{IH}	Input HIGH Current	$V_{IN} = V_{DD}$	$V_{IN} = V_{DD}$			50	μA
V_{OL}	Output LOW Voltage	I _{OL} = 8mA	I _{OL} = 8mA			0.6	V
V _{OH}	Output HIGH Voltage	I _{OH} = -8mA	I _{OH} = -8mA				V
I _{CC}	Static Supply Current	CLKIN & PD#/OE p	ins pulled to GND			2	μA
			2MHz		2		
I _{DD}	Dynamic Supply Current	Unloaded Output	6MHz		5		mA
			16MHz		6		
Zo	Output Impedance				36		Ω

Electrical Characteristics for 3.3V Supply

Parameter	Description	Test C	Test Conditions		Тур	Max	Unit
V_{DD}	Supply Voltage			3.0	3.3	3.6	V
V_{IH}	Input HIGH Voltage			2.0			V
V_{IL}	Input LOW Voltage					0.8	V
I _{IH}	Input HIGH Current	$V_{IN} = V_{DD}$				50	μA
I _{IL}	Input LOW Current	$V_{IN} = 0V$	V _{IN} = 0V			50	μΑ
V_{OH}	Output HIGH Voltage	I _{OH} = -8mA	I _{OH} = -8mA				V
V_{OL}	Output LOW Voltage	I _{OL} =8mA	I _{OL} =8mA			0.4	V
I _{CC}	Static Supply Current	CLKIN pulled Low, P	D#/OE pulled Low			2	μA
			2MHz		4		
I _{DD}	Dynamic Supply Current	Unloaded outputs	6MHz		7		mA
			20MHz		9		
Z _o	Output Impedance				27		Ω



Switching Characteristics for 2.5V

Parameter	Test Con	Min	Тур	Max	Unit		
	FS=0	2		6			
Input Frequency	FS=1		6		₩16W.I	DataSheet4L	J.coi
MadOUT	FS=0		2		6	MHz	
ModOUT	FS=1		6		16		
Duty Cycle ^{1, 2}	Measured at V _{DD} /2	45	50	55	%		
Rise Time ^{1, 2}	Measured between 20%		1.7		nS		
Fall Time ^{1, 2}	Measured between 80%		0.9		nS		
0		FS=0; @ 5 MHz		±225		0	
Cycle-to-Cycle Jitter ²	Unloaded outputs	FS=1; @ 15 MHz		±150		pS	
	Unloaded outputs with	FS=0; @ 6 MHz		175			
Input-to-Output propagation Delay ²	SSEXTR pin OPEN, No load on DLY_CTRL	FS=1; @ 12 MHz		75		pS	
PLL Lock Time ²	Stable power supply, val			3	mS		

Notes: 1. All parameters are specified with 10 pF loaded outputs

Switching Characteristics for 3.3V

Parameter	Test Con	ditions	Min	Тур	Max	Unit
land Francisco	FS=0	2		6		
Input Frequency	FS=1		6		20	
Madout	FS=0		2		6	MHz
ModOUT	FS=1		6		20	
Duty Cycle 3,4	Measured at V _{DD} /2		45	50	55	%
Rise Time ^{3,4}	Measured between 20%		1.2		nS	
Fall Time 3,4	Measured between 80%		0.8		nS	
Cycle-to-Cycle Jitter ⁴	Unloaded outputs	FS=0; @ 5 MHz		±200		pS
Gyale-to-Gyale sitter	Officaded outputs	FS=1; @ 15 MHz		±125		ро
	Unloaded outputs with	FS=0; @ 6 MHz		-75		
Input-to-Output propagation Delay 4	SSEXTR pin OPEN, No load on DLY_CTRL	FS=1; @ 12 MHz		125		pS
PLL Lock Time ⁴	Stable power supply, val CLKIN pin	id clock presented on			3	mS

Notes: 3. All parameters are specified with 10 pF loaded outputs

^{2.} Parameter is guaranteed by design and characterization. Not 100% tested in production

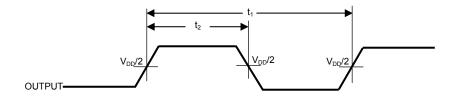
^{4.} Parameter is guaranteed by design and characterization. Not 100% tested in production



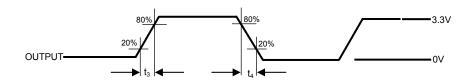
Switching Waveforms

Duty Cycle Timing

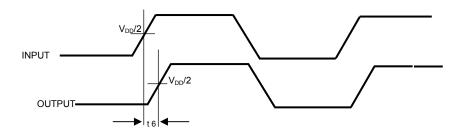
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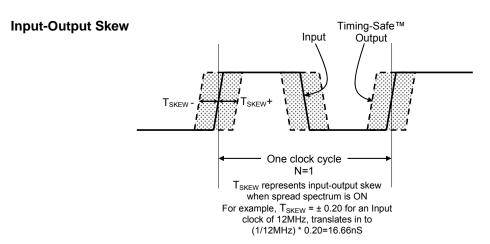


All Outputs Rise/Fall Time



Input - Output Propagation Delay

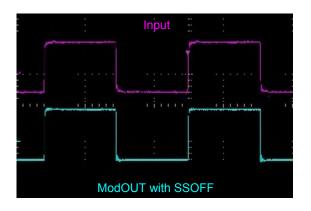


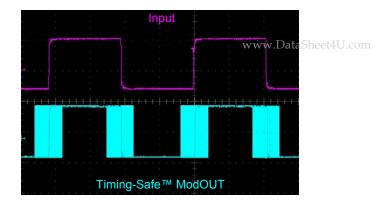


Note: Tskew is measured in units of Clock Period

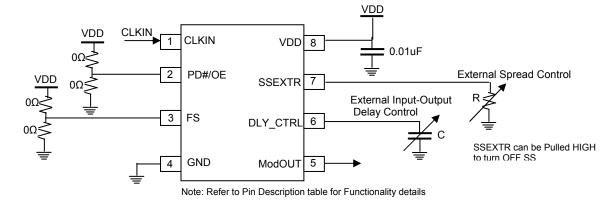


Typical example of Timing-Safe™ waveform





Typical Application Schematic





Charts (for VDD=2.5V±0.2V and 3.3V±0.3V)

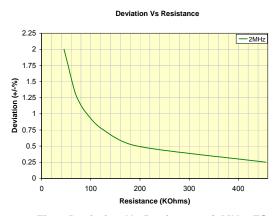


Fig1: Deviation Vs Resistance (2MHz, FS=0)

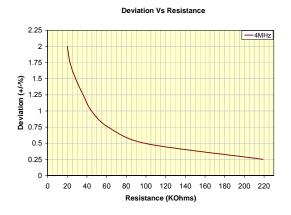


Fig3: Deviation Vs Resistance (4MHz, FS=0)

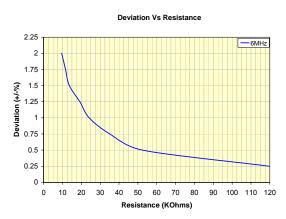


Fig5: Deviation Vs Resistance (6MHz, FS=0)

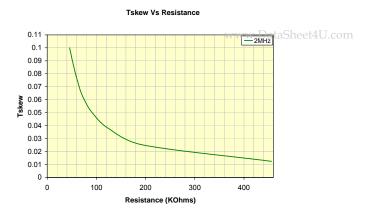


Fig2: Tskew Vs Resistance (2MHz, FS=0)

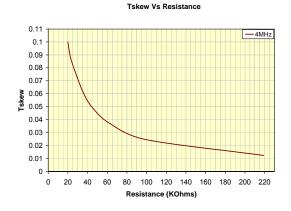


Fig4: Tskew Vs Resistance (4MHz, FS=0)

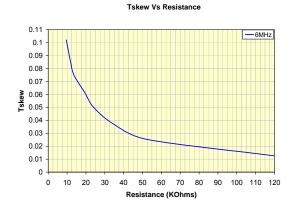


Fig6: Tskew Vs Resistance (6MHz, FS=0)

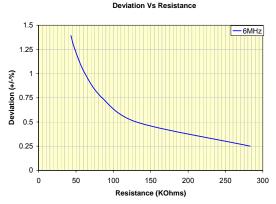


Fig7: Deviation Vs Resistance (6MHz, FS=1)

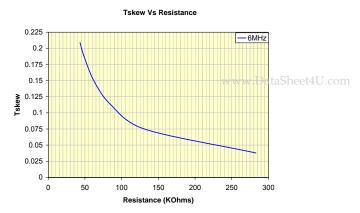


Fig8: Tskew Vs Resistance (6MHz, FS=1)

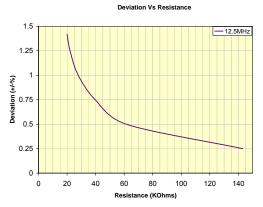


Fig9: Deviation Vs Resistance (12.5MHz, FS=1)

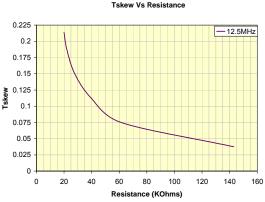


Fig10: Tskew Vs Resistance (12.5MHz, FS=1)

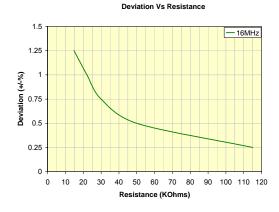


Fig11: Deviation Vs Resistance (16MHz, FS=1)

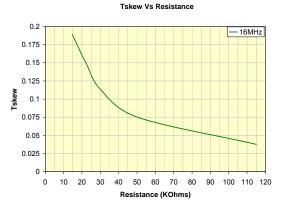


Fig12: Tskew Vs Resistance (16MHz, FS=1)



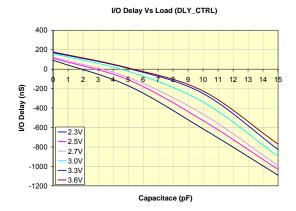


Fig13: I/O Delay Vs Load (DLY_CTRL) (For 2MHz, FS=0)

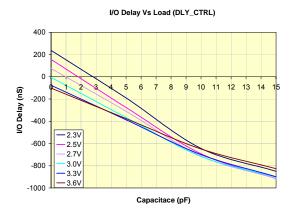


Fig15: I/O Delay Vs Load (DLY_CTRL) (For 6MHz, FS=0)

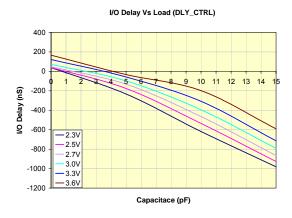


Fig17: I/O Delay Vs Load (DLY_CTRL) (For 12.5MHz, FS=1)

Note: Device to Device variation of Deviation and I/O delay is ± 10%

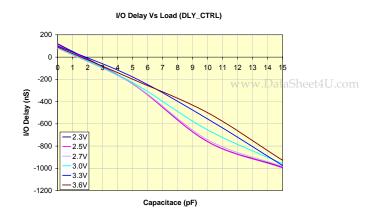


Fig14: I/O Delay Vs Load (DLY_CTRL) (For 4MHz, FS=0)

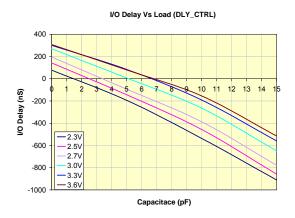


Fig16: I/O Delay Vs Load (DLY_CTRL) (For 6MHz, FS=1)

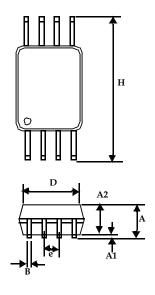


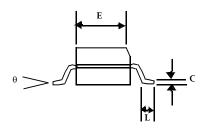
Fig18: I/O Delay Vs Load (DLY_CTRL) (For 16MHz, FS=1)



Package Information

8-lead TSSOP Package (4.40-MM Body)

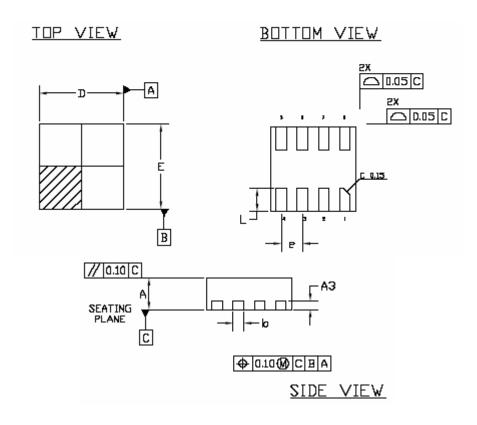




	Dimensions					
Symbol	Incl	hes	Millimeters			
	Min	Max	Min	Max		
Α		0.043		1.10		
A1	0.002	0.006	0.05	0.15		
A2	0.033	0.037	0.85	0.95		
В	0.008	0.012	0.19	0.30		
С	0.004	0.008	0.09	0.20		
D	0.114	0.122	2.90	3.10		
E	0.169	0.177	4.30	4.50		
е	0.026 BSC		0.65 BSC			
Н	0.252	BSC	6.40 BSC			
L	0.020	0.028	0.50	0.70		
θ	0°	8°	0°	8°		



TDFN COL 2x2 8L package Outline drawing



	Dimensions				
Symbol	Inches		Mill	imeters	
	Min	Max	Min	Max	
Α	0.027	0.0315	0.70	0.80	
A3	0.008	BSC	0.203 BSC		
b	0.008	0.012	0.20	0.30	
D	0.079 BSC		2.0	00 BSC	
Е	0.078 BSC		2.00 BSC		
е	0.020 BSC		0.5	0 BSC	
L	0.020	0.024	0.50	0.60	

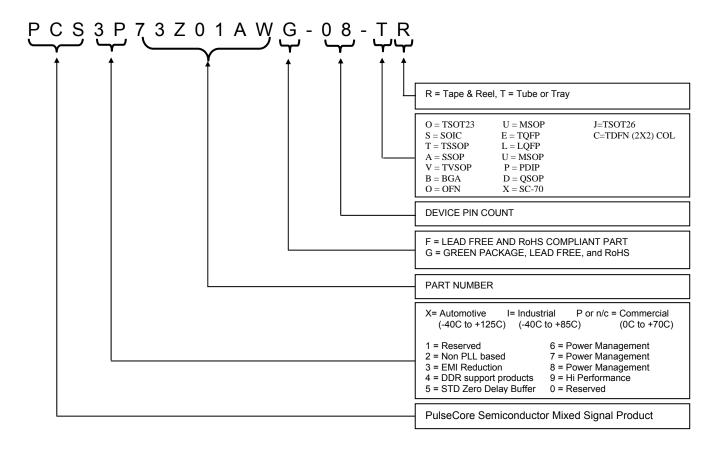


rev 0.3 Ordering Codes

Ordering Code	Marking	Package Type	Temperature
PCS3P73Z01AWG-08-TT	3P73Z01AWG	8-pin 4.4-mm TSSOP - TUBE, Green	Commercial
PCS3P73Z01AWG-08-TR	3P73Z01AWG	8- pin 4.4-mm TSSOP - TAPE & REEL, Green	Commercial Sheet
PCS3P73Z01AWG-08-CR	AE1LL	8- pin 2-mm TDFN COL - TAPE & REEL, Green	Commercial

LL = 2 Character LOT #

Device Ordering Information



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Note: This product utilizes US Patent #6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003

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